

VL6180X

Proximity and ambient light sensing (ALS) module



- Two programmable GPIO
 - Window and thresholding functions for both ranging and ALS

Applications

- Smartphones/portable touchscreen devices
- Tablet/laptop/gaming devices
- Domestic appliances/industrial devices

Description

The VL6180X is the latest product based on ST's patented FlightSense[™] technology. This is a ground-breaking technology allowing absolute distance to be measured independent of target reflectance. Instead of estimating the distance by measuring the amount of light reflected back from the object (which is significantly influenced by color and surface), the VL6180X precisely measures the time the light takes to travel to the nearest object and reflect back to the sensor (Time-of-Flight).

Combining an IR emitter, a range sensor and an ambient light sensor in a three-in-one ready-touse reflowable package, the VL6180X is easy to integrate and saves the end-product maker long and costly optical and mechanical design optimizations.

The module is designed for low power operation. Ranging and ALS measurements can be automatically performed at user defined intervals. Multiple threshold and interrupt schemes are supported to minimize host operations.

Host control and result reading is performed using an I²C interface. Optional additional functions, such as measurement ready and threshold interrupts, are provided by two programmable GPIO pins.

Features

- Three-in-one smart optical module
 - Proximity sensor
 - Ambient Light Sensor
 - VCSEL light source
- Fast, accurate distance ranging
 - Measures absolute range from 0 to above 10 cm (ranging beyond 10cm is dependent on conditions)
 - Independent of object reflectance
 - Ambient light rejection
 - Cross-talk compensation for cover glass
- Gesture recognition
 - Distance and signal level can be used by host system to implement gesture recognition
 - Demo system available: P-NUCLEO-6180X1 evaluation board
- Ambient light sensor
 - High dynamic range
 - Accurate/sensitive in ultra-low light
 - Calibrated output value in lux
- Easy integration
 - Single reflowable component
 - No additional optics
 - Single power supply
 - I²C interface for device control and data
 - Provided with a documented C portable API (Application Programming Interface)

This is information on a product in full production.

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1 Overview

This datasheet is applicable to the final VL6180X ROM code revision.

1.1 Technical specification

Feature	Detail		
Package	Optical LGA12		
Size	4.8 x 2.8 x 1.0 mm		
Ranging	0 to 100 mm ⁽¹⁾		
Ambient light sensor	< 1 Lux up to 100 kLux ⁽²⁾ 16-bit output ⁽³⁾ 8 manual gain settings		
 Operating voltage: Functional range Optimum range⁽⁴⁾ 	2.6 to 3.0 V 2.7 to 2.9 V		
Operating temperature: Functional range Optimum range⁽⁴⁾ 	-20 to 70°C -10 to 60°C		
Typical power consumption	Hardware standby (GPIO0 = 0): < 1 μ A ⁽⁵⁾ Software standby: < 1 μ A ^(5.) ALS: 300 μ A Ranging: 1.7 mA (typical average) ⁽⁶⁾		
IR emitter	850 nm		
l ² C	400 kHz serial bus Address: 0x29 (7-bit)		

Table	1.	Technical	specification
	•••		opeenieanen

1. Ranging beyond 100mm is dependent on target reflectance and external conditions (ambient light level, temperature, voltage)

2. When used under a cover glass with 10% transmission in the visible spectrum

- 3. Digital output easily converted to Lux
- 4. Please refer to *Table 18.: Ranging specification*
- 5. GPIO0, GPIO1, SCL and SDA are pulled up to AVDD (2.8V)
- 6. Assumes 10 Hz sampling rate, 17% reflective target at 50 mm



1.2 System block diagram



1.3 Device pinout

Figure 2 shows the pinout of the VL6180X.







Pin number	Signal name	Signal type	Signal description		
1	GPIO1	Digital I/O	Interrupt output. Open-drain. If used, it should be pulled high with 47 k Ω resistor, otherwise left unconnected.		
2	NC		No connect		
3	NC		No connect		
4	GPIO0/CE	Digital I/O	Power-up default is chip enable (CE). It should be pulled high with a 47 k Ω resistor.		
5	SCL	Digital input	I ² C serial clock		
6	SDA	Digital I/O	I ² C serial data		
7	NC		No connect		
8	AVDD_VCSEL	Supply	VCSEL power supply 2.6 to 3.0 V		
9	AVSS_VCSEL	Ground	VCSEL ground		
10	AVDD	Supply	Digital/analog power supply 2.6 to 3.0 V		
11	NC		No connect		
12	AVSS	Ground	Digital/analog ground		

Table 2. VL6180X pin numbers and signal descriptions

1.4 Typical application schematic

Figure 3 shows a typical application schematic of the VL6180X.



Figure 3. Root part number 1 schematic

1. Open drain. If pin is used, then 47 k $\!\Omega$ recommended, otherwise leave floating

2. Open drain, 47 k Ω recommended

3. Open drain. Pull up resistors typically fitted once per I^2C bus at host

Note: Capacitors on AVDD and AVDD_VCSEL should be placed as close as possible to the supply pads.



1.5 Recommended solder pad dimensions

Figure 4. Recommended solder pattern



1.6 Recommended reflow profile

The recommend reflow profile is shown in Figure 5 and Table 3.



 Table 3. Recommended reflow profile

Profile	Ramp to strike		
Temperature gradient in preheat	(T= 70 - 180°C):	0.9 +/- 0.1°C/s	
Temperature gradient	(T= 200 - 225°C):	1.1 - 3.0°C/s	
Peak temperature in reflow	237°C - 245°C		
Time above 220°C	50 +/- 10 seconds		
Temperature gradient in cooling	-1 to -4 °C/s (-6°C/s maximum)		
Time from 50 to 220°C	160 to 220 seconds		

Note:

As the VL6180X package is not sealed, only a dry re-flow process should be used (such as convection re-flow). Vapor phase re-flow is not suitable for this type of optical component.

The VL6180X is an optical component and as such, it should be treated carefully. This would typically include using a 'no-wash' assembly process.



2 Functional description

This section gives an overview of the key features of the VL6180X and describes the different modes of operation of the ALS and proximity sensor.

A complete API is also associated to the device which consists of a set of C functions controlling the VL6180X to enable fast development of end-user applications. This API is structured in a way that it can be complied on any kind of platform through a well isolated platform layer (mainly for low level I²C access). It is available for download from www.st.com.

It is assumed in the rest of the document that the host application is controlling the VL6180X device through its C API.

For a more detailed explanation of the API functions please refer to the documentation that is supplied with the API.

Typical ranging performance of the VL6180X is shown in *Figure 6*. This demonstrates the reflectance independence and range accuracy of the VL6180X from 0 to 100 mm for 3%, 5%, 17% and 88% reflective targets. The example shown here is with ST cover glass and a 1.0 mm air gap.

Figure 7 shows typical ALS linearity vs gain over a wide dynamic range. More details about the ambient light sensor can be found in *Section 2.10*.



Figure 6. Typical ranging performance





Figure 7. ALS linearity

2.1 **Ranging pipe**

The VL6180X uses a simple architecture to achieve range measurement.



Figure 8. Ranging pipe architecture

2.2 System state diagram

Convergence Time (us)

Figure 9 describes the main operating states of the VL6180X. Hardware standby is the reset state (GPIO0=0)^(a). The device is held in reset until GPIO0 is de-asserted. Note that the device will not respond to I²C communication in this mode. When GPIO0=1, the device enters software standby after the internal MCU boot sequence has completed.



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Actual Range

Cross-talk Compensation

Actual Range

From customer application point of view, the following sequence must be followed at the power-up stage

- Set GPIO0 to 0
- Set GPIO0 to 1
- Wait for a minimum of 400μs
- Call VL6180x_WaitDeviceBooted()^(b) API function (or wait for 1ms to ensure device is ready).

Then, at this stage, through API functions calls, it is possible to:

- 1. Configure the device to start single-shot ranging or ALS measurements.
- 2. Configure the device into continuous mode where the device uses an internal timer to schedule range/ALS measurements at specified intervals. See Section 2.5.4: Interleaved mode.



Figure 9. System state diagram

- a. Use of GPIO0 is optional
- b. Warning: The VL6180x_WaitDeviceBooted() function expects the device to be fresh out of reset. Calling this function when the device is not fresh out of reset will result in an infinite loop.



2.3 Timing diagram

Figure 10 and *Table 4*.show the Root part number 1 power-up timing constraints.

- AVDD_VCSEL must be applied before or at the same time as AVDD.
- GPIO0 defaults to an active low shutdown input. When GPIO0 = 0, the device is in hardware standby. If GPIO0 is not used it should be connected to AVDD.
- The internal microprocessor (MCU) boot sequence commences when AVDD is up and GPIO0 is high whichever is the later.
- GPIO1 power-up default is output low. It is tri-stated during the MCU boot sequence.

Note:

In hardware standby, GPIO1 is output low and will sink current through any pull-up resistor. This leakage can be minimized by increasing the value of the pull-up resistor.

 After the MCU boot sequence the device enters software standby. Host initialization can commence immediately after entering software standby.



Figure 10. Power-up timing

Table 4. Power-up timing constraints

Symbol	Parameter	Min	Max	Unit
t1	AVDD_VCSEL power applied after AVDD	-	0	ms
t2	Minimum reset on GPIO0	100	-	ns
t3	GPIO1 output low after hardware standby	-	400	μs
t4	MCU boot	-	1	ms
t5	Software standby to host initialization	-	0	ms



2.4 Software overview

Figure 11 shows a simple start-up routine from initialization to completing an ALS measurement while *Figure 12* shows a simple start-up routine from initialization to completing a range measurement.



2.5 Operating modes

The VL6180X device can operate in 2 different modes:

Single-shot measurement or Continuous measurement for both ranging and ALS.

From these 2 device modes, the VI6180X API enables 3 different typical operating range modes: Polling, interrupt or asynchronous. And 3 different ALS modes: Polling, interrupt and interleaved.

Table 5. describes the operating modes of this device supported by the API.

- Modes 1 and 2 are single-shot range and ALS measurements.
- Modes 3 and 4 are continuous range and ALS operation.
- Mode 5 allows both ALS and range measurements to be scheduled at regular intervals. The ALS measurement is completed first immediately followed by a range measurement. Interleaved mode is described in more detail in *Section 2.5.4*.



Mode	Function	Range		ALS		Priority
Mode	Function	Single	Continuous	Single	Continuous	Friority
1	Range single-shot	•				Range
2	ALS single-shot			•		ALS
3	Range continuous		•			Range
4	ALS continuous				•	ALS
5	Interleaved mode: Range Continuous and ALS Continuous		•		•	-

Table 5. API supported operating modes

Note: Single-shot ALS and range operations cannot be performed simultaneously. Only one of these operations should be performed at any one time and once started must be allowed to complete before another measurement is started. This is because any current operation will be aborted if another is started.

Wrap Around Filter is not available in Continuous range measurement mode.

API operating mode	Description	API functions	VL6180X mode	Comments
Polling	Host requests single shot measurement and waits for the result	VL6180x_RangePollMeasurement	Single shot	Recommended for first API porting or debug
Interrupt	Ranging results are retrieved from interrupts	VL6180x_RangeSetInterMeasPeriod VL6180x_SetupGPIO1 VL6180x_RangeConfigInterrupt (VL6180x_RangeSetThreshold) VL6180x_RangeStartContinuousMode VL6180x_RangeGetMeasurement VL6180x_ClearAllInterrupt	Continuous	Recommended for User Detection applications where CPU is interrupted by VL6180X so can be asleep when no target is detected (power saving)
Asynchro nous	Host requests a single shot measurement and regularly checks to see if result is ready or not	VL6180x_RangeStartSingleShot VL6180x_RangeGetMeasurement IfReady	Single shot	Recommended for AF- Assist applications, Android OS-based system where CPU is synchronized by EOF/SOF from camera or by a timer so that top application controls measurement periods

Table 6. VL6180X range operating modes



API operating mode	Description	API functions	VL6180X mode	Comments
Polling	Host requests single shot measurement and waits for the result	VL6180x_ALSPollMeasurement	Single shot	Recommended for first API porting or debug
Interrupt	ALS results are retrieved from interrupts	VL6180x_SetupGPIO1 VL6180x_AlsConfigInterrupt (VL6180x_AlsSetThresholds) VL6180x_AlsSetSystemMode(Mode_Singl eShot) VL6180x_AlsGetMeasurement VL6180x_ClearAllInterrupt	Single shot	Recommended for AF- Assist applications, where it is used along side ranging.
Interrupt	ALS results are retrieved from interrupts	VL6180x_AlsSetInterMeasurementPeriod VL6180x_SetupGPIO1 VL6180x_AlsConfigInterrupt (VL6180x_AlsSetThresholds) VL6180x_AlsStartContinuousMode VL6180x_AlsGetMeasurement VL6180x_ClearAllInterrupt	Continuous	New ALS value available once per inter-measurement period as defined by user
Interleaved	ALS and ranging results are retrieved from interrupts	VL6180x_AlsConfigInterrupt VL6180x_AlsSetInterMeasurementPeriod VL6180x_StartInterleavedMode (calls VL6180x_AlsStartContinuousMode) VL6180x_AlsGetMeasurement VL6180x_RangeGetMeasurement VL6180x_AlsStopInterleavedMode (calls VL6180x_AlsStopContinuousMode)	Continuous	New ALS and Range values available once per inter-measurement period as defined by user. See <i>Figure 9</i>

Table 7. VL6180X ALS operating modes

Although not supported by the API, it is possible to do a mix of continuous Range and single shot ALS measurements or continuous ALS and single shot Range measurements, as shown below.

- Mode 6 is mixed continuous range and single-shot ALS operation where regular ranging measurements are required with only the occasional ALS measurement.
- Mode 7 is mixed continuous ALS and single-shot range operation where regular ALS measurements are required with only the occasional range measurement.



Mode	Function	R	Range		ALS	Priority
WOUL	Tunction	Single	Continuous	Single	Continuous	Friority
6	Range continuous and ALS single-shot		•	•		ALS
7	ALS continuous and Range single-shot	•			•	Range

Table 8. Non API operating modes

In modes 6 and 7, single-shot operation takes the priority i.e. if a scheduled measurement is in progress when the host requests a single-shot measurement, the scheduled measurement will be aborted and will resume on the next available time slot.



2.5.1 Polling mode - single shot range/ALS measurement

Host calls a blocking API function that requests a single shot measurement and waits for the result. CPU is blocked during this measurement request.



Figure 13. Range polling mode

Figure 14. ALS polling mode





2.5.2 Interrupt mode

The host programs the device in continuous mode and ranging or ALS results are retrieved from interrupts.



Figure 16. ALS Interrupt mode





It is not recommended to run range and ALS continuous modes simultaneously (i.e. asynchronously). Instead, mode 7 'interleaved mode' in *Table 5*. should be used. In 'interleaved mode', scheduled range and ALS measurements operate off a single timer with a range measurement proceeding immediately after every ALS measurement.

VL6180x_RangeConfigInterrupt() or VL6180x_AlsConfigInterrupt()

The VL6180X can be configured to generate a range or ALS interrupt flag under any of the following conditions:

- New sample ready
- Level low (range/ALS value < low threshold)
- Level high (range/ALS value > high threshold)
- Out of window (range/ALS value < low threshold) OR (range/ALS value > high threshold)

In new sample ready mode (continuous mode - WAF disabled), an interrupt flag will be raised at the end of every measurement irrespective of whether the measurement is valid or if an error has occurred.

In level interrupt mode the system will raise an interrupt flag if either a low or high programmable threshold has been crossed.

Out of window interrupt mode activates both high and low level thresholds allowing a window of operation to be specified.

Range interrupt modes are selected via VL6180x_RangeConfigInterrupt() with VL6180x_RangeSetThresholds() used to set thresholds. Use VL6180x_RangeGetInterruptStatus() to return the ranging interrupt status.

ALS interrupt modes are selected via VL6180x_AlsConfigInterrupt() with VL6180x_AlsSetThresholds() used to set thresholds. Use VL6180x_AlsGetInterruptStatus() to return the ALS interrupt status.

Note: In level or window interrupt modes range errors will only trigger an interrupt if the logical conditions described above are met.

Continuous mode limits

To take account of oscillator tolerances and internal processing overheads it is necessary to place the following constraints on continuous mode operations. The following equations define the minimum inter-measurement period to ensure correct operation:

Continuous range:

```
VL6180x_RangeSetMaxConvergenceTime() + 5 \le VL6180x_RangeSetInterMeasPeriod() * 0.9
```

Continuous ALS:

VL6180x_AlsSetIntegrationPeriod() * $1.1 \le$ VL6180x_AlsSetInterMeasurementPeriod() * 0.9

Interleaved mode:

 $\begin{array}{l} (VL6180x_RangeSetMaxConvergenceTime() + 5) + \\ (VL6180x_AlsSetIntegrationPeriod() * 1.1) \leq \\ VL6180x_AlsSetInterMeasurementPeriod() * 0.9 \end{array}$



Table 9. gives an example how to apply these limits in continuous interleaved mode operating at a sampling rate of 10 Hz.

Table 3. Interfeaved mode mints (10 Hz operation)					
Parameter	Period (ms)				
VL6180x_AlsSetInterMeasurementPeriod()	100				
Effective ALS INTERMEASUREMENT PERIOD	90				
VL6180x_RangeSetMaxConvergenceTime()	30				
Total RANGE EXECUTION TIME	35				
VL6180x_AlsSetIntegrationPeriod()	50				
Total ALS INTEGRATION TIME	55				
TOTAL EXECUTION TIME	90				

2.5.3 Asynchronous mode - single shot range measurement

Host requests a single shot measurement and can either check regularly to see if result is ready or wait for an interrupt then call **RangeGetMeasurementIfReady()**.







2.5.4 Interleaved mode

Figure 19. describes the continuous interleaved mode of operation where an ALS measurement is immediately followed by a range measurement and repeated after an interval specified by the ALS inter-measurement period.





Note: Continuous range settings have no effect in this mode.





Figure 19. Interleaved mode

Note:

To ensure correct operation in any of the continuous modes, the user must ensure that the inter-measurement period is sufficient for the operation to be completed within the inter-measurement period. Failure to do so could result in unpredictable behavior.

2.6 History buffer

History buffer not yet implemented in API.

The history buffer is a 8 x 16-bit memory which can be used to store the last 16 range measurements (8-bit) or 8 ALS samples (16-bit). Use of the history buffer is controlled via register SYSTEM_HISTORY_CTRL{0x12}. There are 3 basic functions:

- enable
- range or ALS selection
- clear buffer

The buffer is read via eight 16-bit registers (RESULT_HISTORY_BUFFER_0{0x52} to RESULT_HISTORY_BUFFER_7{0x60}). The buffer holds the last 16 x 8-bit range or 8 x 16-bit ALS results as shown in *Table 10*.

History buffer	Ra	ALS		
History buffer	(High byte)	(Low byte)	(Word)	
0	Range [15] (newest)	Range [14]	ALS [7] (newest)	
1	Range [13]	Range [12]	ALS [6]	
2	Range [11]	Range [10]	ALS [5]	
3	Range [9]	Range [8]	ALS [4]	
4	Range [7]	Range [6]	ALS [3]	
5	Range [5]	Range [4]	ALS [2]	
6	Range [3]	Range [2	ALS [1]	
7	Range [1]	Range [0] (oldest)	ALS [0] (oldest)	



Note: Only one data stream (ALS or range) can be buffered at one time. There is no associated time stamp information.

The clear buffer command is not immediate; it takes effect on the next range or ALS start command.

The history buffer works independently of interrupt control i.e. the history buffer records all new samples; its operation is unchanged in threshold and window modes.

2.7 Range Sensor

The VL6180X contains a range sensor capable of measuring distance up to 10cm (ranging beyond 10cm is condition dependent). This section describes the main features of the range sensor. The range sensor performance specification can be found in *Section 3.1*.

2.7.1 Range timing

Figure 20 gives a breakdown of total execution time for a single range measurement.

- The pre-calibration phase is fixed (3.2 ms).
- The range convergence time is variable and depends on target distance/reflectance (see *Table 11*).
- The recommended readout averaging period is 4.3 ms. Readout averaging helps to reduce measurement noise. The recommended setting for READOUT__AVERAGING_SAMPLE_PERIOD{0x10A} is 48^(c) but is programmable in the range 0-255. Note however that lower settings will result in increased noise.

Register $READOUT_AVERAGING_SAMPLE_PERIOD{0x10A}$ is not programmable via the API.

Note: When a target is detected the API returns the actual range convergence time. The convergence time returned by the API does not include the readout average. Range convergence and readout averaging must be completed within the specified max convergence time.

VL6180x_RangeSetMaxConvergenceTime() - sets maximum time to run measurement in all ranging modes. Range = 1 - 63 ms; measurement aborted when limit reached. Effective max convergence time depends on the actual convergence time plus readout averaging sample period setting.



Figure 20. Total range execution time



c. Default readout averaging period is calculated as follows: 1300 µs + (48 x 64.5 µs) = 4.3 ms

Range (mm)	Target reflectance				
Kange (mm)	3%	5%	17%	88%	
10	0.43	0.33	0.18	0.18	
20	0.94	0.73	0.28	0.18	
30	1.89	1.40	0.51	0.18	
40	3.07	2.25	0.81	0.18	
50	4.35	3.24	1.18	0.24	
60	5.70	4.22	1.60	0.32	
70	7.07	5.35	2.07	0.49	
80	8.41	6.45	2.58	0.50	
90	9.58	7.56	3.14	0.61	
100	10.73	8.65	3.69	0.73	

Table 11. Typical range convergence time (ms)

2.7.2 Range error codes

Before using a measurement returned with a range API function, the application must first check that the function call has succeeded (returned 0) and then check the **Range.errorStatus** for possible error codes.

Table 12 gives a summary of the error codes. Calling

VL6180x_RangeGetStatusErrString() will also return the range error code/description.

Bits [7:4]	its [7:4] Error code Description				
5110 [111]		Decemption			
0	No error	Valid measurement			
1-5	System error	System error detected (can only happen on power on). No measurement possible.			
6	Early convergence estimate	ECE check failed			
7	Max convergence	System did not converge before the specified max. convergence time limit			
8	Range ignore	Ignore threshold check failed			
9-10	Not used	-			
11	Signal to Noise (SNR)	Ambient conditions too high. Measurement not valid			
12/14	Range underflow	Range value < 0 If the target is very close (0-10mm) and the offset is not correctly calibrated it could lead to a small negative value			

Table 12. Range error codes



Bits [7:4]	Error code	Description		
13/15	Range overflow	Range value out of range. This occurs when the target is detected by the device but is placed at a high distance (> 200mm) resulting in internal variable overflow.		
16	Ranging_Filtered ⁽¹⁾	Distance filtered by Wrap Around Filter (WAF). Occurs when a high reflectance target is detected between 600mm to 1.2m		
17	Not used	-		
18	Data_Not_Ready	Error returned by VL6180x_RangeGetMeasurementIfReady() when ranging data is not ready.		

Table 12	. Range	error	codes	(continued)
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1. Errors 16 & 18 require VL6180X API.

2.7.3 Range checks

Error codes 6, 8 and 11 in *Table 12* are configurable by the user (SNR, error 11, has not yet been integrated into the API).

Early convergence estimate (ECE)

Early convergence estimate (ECE) is a programmable feature designed to minimize power consumption when there is no target in the field-of-view (FOV).

The system is said to have 'converged' (i.e. range acquired), when the convergence threshold^(d) is reached before the max. convergence time limit (see *Figure 21*). This ratio specifies the minimum return signal rate required for convergence. If there is no target in the FOV, the system will continue to operate until the max. convergence time limit is reached before switching off thereby consuming power. With ECE enabled, the system estimates the return signal rate 0.5 ms after the start of every measurement. If it is below the ECE threshold, the measurement is aborted and an ECE error is flagged.



Figure 21. Early convergence estimate (ECE)



d. For standard ranging, the convergence threshold is set to 15360. The convergence threshold register is not accessible by the user.

ECE is enabled by setting VL6180x_RangeSetEceState() and configured with VL6180x_RangeSetEceFactor(). This allows the user to change the ECE threshold from the default of 15% below minimum convergence rate. As shown by the example below.

ECE threshold = $\frac{85\% \times 0.5 \times 10240}{\text{Max convergence time (in ms)}}$

If the max convergence time is set to 30 ms (using **VL6180x_RangeSetMaxConvergenceTime()**), then the ECE threshold is 196. That is, if the return count is less than 196 after 0.5 ms, the measurement will be aborted.

Note: The optimum value for the ECE threshold should be determined in the final application.

Range ignore

In a system with cover glass, the return signal from the glass (cross-talk) may be sufficient to cause the system to converge and return a valid range measurement even when there is no target present. The range ignore feature is designed to ensure that the system does not range on the glass. (Cross-talk is described in more detail in *Section 2.8.2*).

The ignore threshold is enabled with VL6180x_RangelgnoreSetEnable(). If enabled, the ignore threshold and valid height must be specified, this is set with VL6180x_RangelgnoreConfigure().

A range ignore error will be flagged if the return signal rate is less than the ignore threshold.

Note: The optimum value for the ignore threshold should be determined in the final application.

Signal-to-noise ratio (SNR)

SNR function not yet implemented in API.

In high ambient conditions range accuracy can be impaired so the SNR threshold is used as a safety limit to invalidate range measurements where the ambient/signal ratio is considered too high. The default ambient/signal ratio limit is 10 (i.e. an SNR of 0.1) which is then encoded in 4.4 format as follows:

SYSRANGE __MAX_AMBIENT_LEVEL_MULT{0x2C} = 10 x 16 = 160

To enable the SNR check, set bit 4 in SYSRANGE_RANGE_CHECK_ENABLES (0x02D). A lower setting results in a more aggressive filter which will result in a lower effective range but greater accuracy. A higher setting results in a less aggressive filter which will result in a greater effective range but lower accuracy.

The SNR value can be calculated as follows:

 $SNR = \frac{RESULT_RANGE_RETURN_SIGNAL_COUNT{0x6C}}{RESULT_RANGE_RETURN_AMB_COUNT{0x74} * 6}$

Note: The SNR value is the inverse of the ambient/signal ratio limit {0x2C}.

Note: The optimum value for SNR threshold should be determined in the final application.



2.7.4 Manual/autoVHV calibration

Manual/auto VHV not yet implemented in API.

SPAD^(e) sensitivity is temperature dependent so VHV^(f) calibration is used to regulate SPAD sensitivity over temperature in order to minimize signal rate variation. VHV calibration is performed either manually by the host processor or automatically by internal firmware. Execution time is typically 200 μ s so has no impact on normal operation.

A VHV calibration is run once at power-up and then automatically after every N range measurements defined by the SYSRANGE__VHV_REPEAT_RATE{0x31} register. AutoVHV calibration is disabled by setting this register to 0. Default is 255. If autoVHV is disabled it is recommended to run a manual VHV calibration periodically to recalibrate for any significant temperature variation. A manual VHV calibration is performed by setting SYSRANGE__VHV_RECALBRATE{0x2E} to 1. This register auto-clears. This operation should only be performed in software standby.

2.7.5 Wrap Around Filter

Wrap-around is an effect linked to the ratio between the VCSEL pulse period and the photon return pulse.



Highly reflective targets (like mirrors) placed at a far distance (>600mm) from the VL6180X can still produce enough return signal for the VL6180X to declare a valid target and meet the wrap-around condition resulting in a wrong (under-estimated) returned distance.

The WAF implemented in the API is able to automatically detect if a target is in the wraparound condition and filter it by returning an invalid distance (**Range.errorStatus** = 16). The WAF is enabled/disabled via **VL6180x_FilterSetState()** and read with **VL6180x_FilterGetState()**.

2.7.6 Maximum ranging distance (DMAX)

A target placed in front of the VL6180X device may not be detected because it is too far away for the given ambient light conditions.

When ambient light level increases, max detection range (Dmax) decreases.

f. VHV is an adjustable SPAD bias voltage and stands for Very High Voltage (typically around 14 V). Also sometimes referred to as CP (Charge Pump).





e. Photon detectors - Single Photon Avalanche Diodes

When no target is detected (no valid distance), the VL6180X API is able to estimate Dmax as the maximum distance up to which a 17% target would have been detected with the current ambient light level.

When no target is detected by the VL6180X, the application can interpret the Dmax value as no target is detected and there is no 17% (or above) target between 0 and Dmax mm.

DMAX is enabled/disabled by VL6180x_DMaxSetState() and read with VL6180x_DMaxGetState().

- Note: Dmax is estimated for a 17% reflectance target. If the real target has a lower reflectance, then the Dmax calculated by the API could be overestimated.
- Note: DMAX requires a large amount of software computation, that may represent a high time overhead for some low MHz CPU. It should be disabled if not required.



2.8 Other ranging system considerations

This section describes part-to-part range offset and system cross-talk. In addition, a procedure for cross-talk calibration is given.

2.8.1 Part-to-part range offset

The VL6180X is factory calibrated to produce an absolute linear range output as shown in *Figure 23*. The part-to-part range offset is calibrated during manufacture and stored in NVM. Use **VL6180x_GetOffsetCalibrationData()** to read offset from device (immediately after **VL6180x_InitData()** this will be the NBVM programmed value). The API always returns the range with the part-to-part offset already applied.





2.8.2 Cross-talk

Cross-talk is defined as the signal return from the cover glass. The magnitude of the crosstalk depends on the type of glass, air gap and filter material. Cross-talk results in a range error (see *Figure 24*) which is proportional to the ratio of the cross-talk to the signal return from the target. The true range is recovered by applying automatic cross-talk compensation.

Figure 24. Cross-talk compensation



Cross-talk compensation is enabled by using VL6180x_SetXTalkCompensationRate(). A cross-talk calibration procedure is described in Section 2.8.4.



2.8.3 Offset calibration procedure

Complete steps 1-4 to see if part-to-part offset calibration is required.

- Turn off WAF VL6180x_FilterSetState() = 0, turn off range ignore features VL6180x_RangeIgnoreSetEnable() = 0 and clear all interrupts VL6180x_ClearAllInterrupt().
- 2. Position a white target (88% reflectance^(g)) at a distance of 50mm from the top of the cover glass.
- 3. Perform a minimum of 10 range measurements and compute the average range using VL6180x_RangePollMeasurement().
- 4. If the average range is within target distance \pm 3 mm, offset calibration is not required. Otherwise, complete the calibration procedure.
- 5. Set VL6180x_SetOffsetCalibrationData() = 0.
- 6. Perform a minimum of 10 range measurements and compute the average range from **VL6180x_RangePollMeasurement()**.
- 7. Calculate the part-to-part offset as follows:

part-to-part offset = target distance(mm) – average range(mm)

8. The new offset value should be stored on system and written to the VL6180X by using VL6180x_SetOffsetCalibrationData() each time the device is reset.

2.8.4 Cross-talk calibration procedure

This section describes a procedure for calibrating system cross-talk.

1. Perform offset calibration if required (see Section 2.8.3) and write the value to the device by using VL6180x_SetOffsetCalibrationData().

Note: If the offset is incorrectly calibrated, cross-talk calibration will be inaccurate.

- Turn off WAF VL6180x_FilterSetState() = 0, turn off range ignore features VL6180x_RangeIgnoreSetEnable() = 0 and clear all interrupts VL6180x_ClearAllInterrupt().
- 3. Position a black target (3% reflectance^(h)) at a distance of 100mm from the top of the cover glass.
- 4. Write 0 to VL6180x_SetXTalkCompensationRate().
- 5. Perform a minimum of 10 range measurements and compute the average return rate and range value from VL6180x_RangePollMeasurement().
- 6. Calculate the cross-talk factor as follows:

cross-talk (in Mcps) = average return rate $\times \left(1 - \frac{\text{average range(mm)}}{\text{target distance(mm)}}\right)$

7. The cross-talk value should be stored on system and written to the VL6180X by using VL6180x_SetXTalkCompensationRate() each time the device is reset.

Note:

Cross-talk compensation is only applied to targets above 20 mm. This is to ensure that cross-talk correction is not applied to near targets where the signal rate is decreasing.

h. Target reflectance should be low but absolute value is not critical.



g. Target reflectance should be high but absolute value is not critical.

2.8.5 Cross-talk limit

A practical limit for cross-talk is < 3.0 Mcps for standard ranging. This is based on two factors:

- 1. The return rate for a 3% reflective target at 100 mm without glass is typically around 1.5 Mcps. If glass is added with a cross-talk of 3.0 Mcps, the resultant return rate will be 4.5 Mcps. This results in a cross-talk correction factor of x3 so for a 100 mm target the raw range will be in the region of 30 mm. To ensure the cross-talk valid height restriction is not breached, the minimum raw range allowing for noise margin is around 30 mm.
- 2. A cross-talk correction factor of x3 also means that any range noise will be multiplied by 3 so noise also becomes a limiting factor.

2.8.6 Cross-talk vs air gap

Figure 25 shows the typical cross-talk vs air gap using low cross-talk cover glass. Above 1.5 mm, the cross-talk rises rapidly.



Figure 25. Cross-talk vs air gap



2.9 Current consumption

Table 13. gives an overview of current consumption in different operating states.

Mode	Current	Conditions		
Hardware standby < 1 μA		Shutdown (GPIO0 = 0). No I^2C comms		
Software standby < 1 µA		After MCU boot. Device ready		
ALS	300 μA	During integration		
Ranging	1.7 mA	Average consumption during ranging ⁽¹⁾		

Table 13. Typical curren	t consumption in different	operating states
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1. 10 Hz sampling rate, 17% reflective target at 50 mm.

2.9.1 Ranging current consumption

Figure 26. shows typical ranging current consumption of the VL6180X. Current consumption depends on target distance, target reflectance and sampling rate. The example shown here is based on default settings and a sampling rate of 10 Hz. The average current consumption for a 17% reflective target at 50 mm operating at 10 Hz is 1.7 mA. At different sampling rates the current consumption scales accordingly i.e. the average current consumption at 1 Hz under the same conditions would be 0.17 mA.





The minimum average current consumption in *Figure 26.* is 1.5 mA, 0.5 mA of which comes from pre-calibration before each measurement and 1.0 mA from post-processing (readout averaging). Pre-calibration is a fixed overhead but readout averaging can be reduced or effectively disabled by setting the READOUT__AVERAGING_SAMPLE_PERIOD{0x10A} to zero (default setting is 48).

Note: Decreasing the *READOUT__AVERAGING_SAMPLE_PERIOD* will increase sampling noise. It is recommended that any change in setting be properly evaluated in the end application.

Minimum current consumption scales with sampling rate i.e. at a sampling rate of 1 Hz the current consumption associated with pre- and post-processing will be 0.15 $\mu A.$



2.9.2 Current consumption calculator

Table 14. gives a breakdown of typical current consumption for pre-calibration, ranging and readout averaging.

Label	Phase	l (mA)	t (ms)	Q (μC) = I x t
Q ₁	Pre-calibration	13.0	3.2	41.6
Q ₂	Ranging	22.0	per ms	22.0 per ms
Q ₃	Readout averaging	25.0	per ms	25.0 per ms

Table 14. Breakdown of current consumption

Current consumption can then be calculated as follows:

 $\begin{array}{l} I \ (\mu A) = sampling_rate \ ^* \left[Q_1 + \left(Q_2 \ ^* \ \text{RESULT}_\ \text{RANGE}_\text{RETURN}_\text{CONV}_\text{TIME} \ \text{in ms} \right) + \\ Q_3 \ ^* \ (1.3 + \left(\text{READOUT}_\ \text{AVERAGING}_\text{SAMPLE}_\text{PERIOD} \ ^* \ 0.0645 \ \text{ms} \right)) \end{array}$

Table 11. gives typical convergence times for different target reflectance.

So, for example, RESULT__RANGE_RETURN_CONV_TIME for a 3% target at 50 mm is 4.35 ms. At 10 Hz sampling rate this gives:

 $I (\mu A) = 10 * [41.6 + (22 * 4.35) + 25 * (1.3 + (48 * 0.0645))] = 2472 \ \mu A$

2.9.3 Current distribution

Table 15. shows how current consumption is distributed between the two supplies in ranging mode. AVDD_VCSEL supplies the VCSEL current and AVDD supplies all other functions.

Angle of divergent laser emission is 25° +/- 5°. The condition of divergent angle of 25° laser emission is 1/e² of the peak intensity

Note: The VCSEL driver is pulsed at 100 MHz with a 33% duty cycle (see Figure 27.) so average current consumption on AVDD_VCSEL is one third of the peak.

Power supply ⁽¹⁾	Current	Note
AVDD	14 mA	Average during active ranging
AVDD_VCSEL	8 mA ⁽²⁾	Average during active ranging (33% duty cycle).

1. Normally, both supplies will be driven from a common source giving a peak instantaneous current demand of 38 mA.

2. Peak emitter current during ranging is 24 mA. Peak power is 14mW.

Figure 27. VCSEL pulse duty cycle




2.10 Ambient light sensor (ALS)

The VL6180X contains an ambient light sensor capable of measuring the ambient light level over a wide dynamic range. This section describes the main features of the ALS. The ALS performance specification can be found in *Section 3.2*.

2.10.1 Field of view

Figure 28 shows the ALS field of view which is typically 42 degrees (half angle, 40% of peak) in both X and Y.



Figure 28. ALS angular response

2.10.2 Spectral response

The spectral response of the ALS compared to photopic response is shown in Figure 29.



Figure 29. ALS spectral response



2.10.3 ALS dynamic range

Table 16 shows the range of measurable light at all gains both with and without glass. In most applications operating at a single gain setting should be possible.

			<u> </u>	
Analogue	Dynamic ran	ge (no glass)	-	ange (10% sive glass)
gain setting	Min. (Lux) ⁽²⁾	Max. (Lux)	Minimum (Lux)	Maximum (Lux)
1	3.20	20800	32.0	>100,000
1.25	2.56	16640	25.6	>100,000
1.67	1.93	12530	19.3	>100,000
2.5	1.28	8320	12.8	83,200
5	0.64	4160	6.4	41,600
10	0.32	2080	3.2	20,800
20	0.16	1040	1.6	10,400
40	0.08	520	0.8	5,200

Table 16. ALS dynamic range⁽¹⁾

1. ALS lux resolution = 0.32 lux/count

2. Minimum of 10 counts

2.10.4 ALS count to lux conversion

The output from the ambient light sensor is a 16 bit count value, this count output is proportional to the light level and is converted into lux with VL6180x_AlsGetLux(). The ALS read measurement functions VL6180x_AlsPollMeasurement() & VL6180x_AlsGetMeasurement() both call this function.

The conversion from count to lux is dependent on the ALS lux resolution, ALS gain and integration period:

Light level (in lux) = ALS lux resolution $\times \frac{ALS \text{ count}}{Analog \text{ gain}} \times \frac{100 \text{ ms}}{ALS \text{ integration time}}$

The factory calibrated ALS lux resolution is 0.32 lux/count for an analog gain of 1 & 100ms integration time (calibrated without glass). The current lux resolution value can be read by using VL6180x_AlsGetLuxResolutionFactor().

The ALS lux resolution will require re-calibration in the final system where cover glass is used. This can be done by reading the lux value with and without glass under the same conditions and multiplying the ALS lux resolution by the ratio of the two values as shown below. The new value can be written to the device by using **VL6180x_AlsSetLuxResolutionFactor()**.

ALS lux resolution (with glass) = $\frac{LuxValue(without glass)}{LuxValue(with glass)} \times ALS$ lux resolution (without glass)



2.10.5 Integration period

The integration period (**VL6180x_AlsSetIntegrationPeriod()**) is the time over which a single ALS measurement is made. The default integration period is 100ms. Integration times in the range 50-100 ms are recommended to reduce impact of light flicker from artificial lighting.

2.10.6 ALS gain selection

Eight analog gain settings (VL6180x_AlsSetAnalogueGain()) are available which can be selected manually depending on the range and resolution required. shows the actual characterized gains versus the design targets. If a gain setting other than gain 20 is used, marginally greater accuracy can be achieved by using the actual gain values in the light level equation in *Section 2.10.4* when calculating the lux light level.

VL6180x_Als SetAnalogueGain	Analog gain setting	Actual gain values
0x46	1	1.01
0x45	1.25	1.28
0x44	1.67	1.72
0x43	2.5	2.60
0x42	5	5.21
0x41	10	10.32
0x40	20	20
0x47	40	40

Table 17. Actu	al gain values
----------------	----------------

2.10.7 Scaler

In addition to analogue gain, the VL6180X has a scaler that multiplies the ALS count prior to the result being read. This value, in addition to the analogue gain is useful in very low light conditions to increase the dynamic range.

The scaler can be a value between 1 to 16 (default 1) and is set with **VL6180x_ALSSetScaler()** and read with **VL6180x_ALSGetScaler()**.



3 Performance specification

3.1 **Proximity ranging (0 to 100mm)**

The following table specifies ranging performance up to 100mm. Ranging beyond 100mm is possible with certain target reflectances and ambient conditions but not guaranteed. These results are derived from characterization of both typical and corner samples (representative of worst case process conditions).

Unless specified otherwise, all results were performed at room temperature (23°C), nominal voltage (2.8V) and in the dark. Results are based on the average of 100 measurements for a 17% reflective target @ 50mm.

Parameter	Min.	Тур.	Max.	Unit
Noise ⁽¹⁾	-	-	2.0	mm
Range offset error ⁽²⁾	-	-	13	mm
Temperature dependent drift ⁽³⁾	-	9	15	mm
Voltage dependent drift ⁽⁴⁾	-	3	5	mm
Convergence time ⁽⁵⁾	-	-	15	ms

Table 18. Ranging specification

1. Maximum standard deviation of 100 measurements

2. Maximum offset drift after 3 reflow cycles. This error can be removed by re-calibration in the final system

- 3. Tested over optimum operating temperature range (see Table 23.: Normal operating conditions)
- 4. Tested over optimum operating voltage range (see Table 23.: Normal operating conditions)
- 5. Based on a 3% reflective target @ 100 mm

3.1.1 Max range vs. ambient light level

The data shown in this section is worst case data for reference only.

Table 19 shows the worst case maximum range achievable under different ambient light conditions

Iac	Table 19. Worst case max range vs. ambient 0 to 100mm										
Target reflectance	In the dark ⁽³⁾	Worst case indoor light (1 kLux diffuse halogen)	High ambient light (5 kLux diffuse halogen)	Unit							
3%	> 100	> 80	> 40	mm							
5%	> 100	> 90	> 45	mm							
17%	> 100	> 100	> 60	mm							
88%	> 100	> 100	> 70	mm							

Table 19. Worst case max range vs. ambient 0 to 100mm⁽¹⁾⁽²⁾

 Tested in an integrating sphere (repeatable lab test, not representative of real world ambient light) at 1 kLux and 5 kLux (halogen light source) using 80 x 80 mm targets. Due to high IR content, 5 kLux halogen light approximates to 10 kLux to 15 kLux natural sunlight.

2. SNR limit of 0.1 applied. Note: maximum range could be increased by reducing the SNR limit to 0.06

3. Also applicable to lighting conditions with low IR content e.g typical office fluorescent lighting



3.2 ALS performance

The following table specifies ALS performance. These results are derived from characterization of typical samples (without cover glass). Unless specified otherwise, all tests were performed at room temperature (23°C), nominal voltage (2.8V) and using a halogen light source.

Parameter	Min.	Тур.	Max.	Unit
ALS sensitivity ⁽¹⁾	0.28	0.32	0.36	Lux/count
Angular response ⁽²⁾	-	42	-	degrees
Spectral response	-	photopic	-	-
Dynamic Range ⁽³⁾	0.002	-	20971	Lux
Linearity error (1 to 300 lux) ⁽⁴⁾	-	-	5	%
Linearity error (300 to 7500 lux) ⁽⁴⁾	-	-	10	%
Gain error (@ gain 20)	-	-	1	%
Gain error (gains 1 to 10)	-	-	7	%

Table	20.	ALS	performance
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1. 535nm LED @ 1 kLux. Measured @ gain 20.

2. Half angle. 40% transmission.

3. Minimum of one count at gain 40 and 400 ms ALS integration time.

4. Test conditions: -10°C to +60°C; analog gains 1 to 20



4 I²C control interface

The VL6180X is controlled over an I^2C interface. The default I^2C address is 0x29 (7-bit). This section describes the I^2C protocol.



Information is packed in 8-bit packets (bytes) always followed by an acknowledge bit, As for sensor acknowledge and Am for master acknowledge. The internal data is produced by sampling SDA at a rising edge of SCL. The external data must be stable during the high period of SCL. The exceptions to this are start (S) or stop (P) conditions when SDA falls or rises respectively, while SCL is high.

A message contains a series of bytes preceded by a start condition and followed by either a stop or repeated start (another start condition but without a preceding stop condition) followed by another message. The first byte contains the device address (0x52) and also specifies the data direction. If the least significant bit is low (0x52) the message is a master write to the slave. If the lsb is set (0x53) then the message is a master read from the slave.

Figure 31. I²C device address

MSBit							LSBit
0	1	0	1	0	0	1	R/W

All serial interface communications with the sensor must begin with a start condition. The sensor acknowledges the receipt of a valid address by driving the SDA wire low. The state of the read/write bit (lsb of the address byte) is stored and the next byte of data, sampled from SDA, can be interpreted. During a write sequence the second and third bytes received provide a 16-bit index which points to one of the internal 8-bit registers.

Figure 32. Single location, single write)





As data is received by the slave it is written bit by bit to a serial/parallel register. After each data byte has been received by the slave, an acknowledge is generated, the data is then stored in the internal register addressed by the current index.

During a read message, the contents of the register addressed by the current index is read out in the byte following the device address byte. The contents of this register are parallel loaded into the serial/parallel register and clocked out of the device by the falling edge of SCL.

Figure 33. Single location, single read



At the end of each byte, in both read and write message sequences, an acknowledge is issued by the receiving device (that is, the sensor for a write and the master for a read).

A message can only be terminated by the bus master, either by issuing a stop condition or by a negative acknowledge (that is, **not** pulling the SDA line low) after reading a complete byte during a read operation.

The interface also supports auto-increment indexing. After the first data byte has been transferred, the index is automatically incremented by 1. The master can therefore send data bytes continuously to the slave until the slave fails to provide an acknowledge or the master terminates the write communication with a stop condition. If the auto-increment feature is used the master does **not** have to send address indexes to accompany the data bytes.







Figure 35. Multiple location read	Figure	35.	Multi	ple	location	read
-----------------------------------	--------	-----	-------	-----	----------	------

	0x52 (write)							
S	ADDRESS[7:0]	As	IN	IDEX[15:8]	As		INDEX[7:0]	As P
	0x53 (read)							
\rightarrow	S ADDRESS[7:0]	As	DATA[7:0]		Am	DATA[7:0]	Am
$\left(\right)$			_					
4	DATA[7:0]	Am	n	DATA[7:0]	An	n	DATA[7:0]	Am P
	-		•					· · · ·





4.1 I²C interface - timing characteristics

Timing characteristics are shown in *Table 21*. Please refer to *Figure 36* for an explanation of the parameters used.

Symbol	Parameter	Minimum	Typical	Maximum	Unit
F _{I2C}	Operating frequency	0	-	400 ⁽¹⁾	kHz
t _{LOW}	Clock pulse width low	0.5	-	-	μs
t _{HIGH}	Clock pulse width high	0.26	-	-	μs
t _{SP}	Pulse width of spikes which are suppressed by the input filter	-	-	50	ns
t _{BUF}	Bus free time between transmissions	0.5	-	-	μs
t _{HD.STA}	Start hold time	0.26	-	-	μs
t _{SU.STA}	Start set-up time	0.26	-	-	μs
t _{HD.DAT}	Data in hold time	0	-	-	μs
t _{SU.DAT}	Data in set-up time	50	-	-	ns
t _R	SCL/SDA rise time	-	-	120	ns
t _F	SCL/SDA fall time	-	-	120	ns
t _{SU.STO}	Stop set-up time	0.26	-	-	μs
Ci/o	Input/output capacitance (SDA)	-	-	4	pF
Cin	Input capacitance (SCL)	-	-	4	pF
CL	Load capacitance	-	125	-	pF

Table 21. I²C interface - timing characteristics

 The maximum bus speed may also be limited by the combination of load capacitance and pull-up resistor. Please refer to the I²C specification for further information.



Figure 36. I²C timing characteristics

All timing characteristics are measured with respect to V_{IL_MAX} or V_{IH_MIN} .



5 Electrical characteristics

5.1 Absolute maximum ratings

Parameter	Min.	Тур.	Max.	Unit
AVDD	-0.5	-	3.6	V
AVDD_VCSEL	-0.5	-	3.6	V
SCL, SDA, GPIO0 and GPIO1	-0.5	-	3.6	V
VESD (Electrostatic discharge model) Human body model ⁽¹⁾ Charge device model ⁽²⁾	-2 -500		2 500	KV V
Temperature (storage - manufacturing test)	-40	-	+85	°C

1. HBM tests are performed in compliance with ESDA/JEDEC JS-001-2010 (ex: JESD22-A114) MM test is performed in compliance with JESD22-A115.

2. CDM ESD tests are performed in compliance with JESD22-C101.

5.2 Normal operating conditions

Table 23.	Normal	operating	conditions
-----------	--------	-----------	------------

Parameter	Min.	Тур.	Max.	Unit	
Voltage (AVDD and AVDD_VCSEL)	Voltage (AVDD and AVDD_VCSEL)				
Voltage (optimum operating)	2.7	2.8	2.9	V	
Voltage (functional operating)	2.6	2.8	3.0	V	
Temperature					
Temperature (optimum operating)	-10		+60	°C	
Temperature (functional operating)	-20	-	+70	°C	



Note: Stresses above those listed in Table 22. may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

5.3 Electrical characteristics

Symbol	Parameter	Minimum	Typical	Maximum	Unit
CMOS digit	CMOS digital I/O (SDA, SCL, GPIO0 and GPIO1)				
V _{IL}	Low level input voltage	-0.5	-	0.6	V
V _{IH}	High level input voltage	1.12	-	AVDD+0.5	V
V _{OL}	Low level output voltage (8mA load)	-	-	0.4	V
V _{OH}	High level output voltage (8mA load)	AVDD-0.4	-	-	V
I _{IL}	Low level input current	-	-	-10	μΑ
I _{IH}	High level input current	-	-	10	μΑ



6 Device registers

This section describes in detail all user accessible device registers. Registers are grouped by function as shown in *Table 25.* to make them easier to read but also to simplify multi-byte read/write I²C accesses (burst mode). More details in *Section 4.* Reset values are given for each register which denotes the register value in software standby.

Register group	Address range	
IDENTIFICATION	0x00 - 0x0F	
SYSTEM SETUP	0x10 - 0x17	
RANGE SETUP	0x18 - 0x37	
ALS SETUP	0x38 - 0x40	
RESULTS	0x4D - 0x80	

Table 25. Register groups

Note that registers can be 8-,16- or 32-bit. Multi-byte registers are always addressed in ascending order with MSB first as shown in *Table 26*.

Table 20102 Bit register example			
Register address	Byte		
Address	MSB		
Address + 1			
Address + 2			
Address + 3	LSB		

Table 26. 32-bit register example

6.1 Register encoding formats

Some registers are encoded to allow rational numbers to be expressed efficiently. *Table 27* gives an explanation of 9.7 and 4.4 encoding formats.

Format	Description
4.4	8 bits = 4 integer bits + 4 fractional bits (stored as 1 byte) Encoding example: the value 4.2 is multiplied by 16 (2^4) rounded and stored as 67 decimal. Decoding example: 67 is divided by 16 = 4.19.
9.7	16 bits = 9 integer bits + 7 fractional bits (stored over 2 bytes) Encoding example: the value 4.2 is multiplied by 128 (2^7) rounded and stored as 537 decimal. Decoding example: 537 is divided by 128 = 4.19.



Table 2	3. Registe	^r summary
---------	------------	----------------------

Offset	Register name	Reference
0x000	IDENTIFICATIONMODEL_ID	Section 6.2.1 on page 51
0x001	IDENTIFICATIONMODEL_REV_MAJOR	Section 6.2.2 on page 51
0x002	IDENTIFICATIONMODEL_REV_MINOR	Section 6.2.3 on page 51
0x003	IDENTIFICATIONMODULE_REV_MAJOR	Section 6.2.4 on page 52
0x004	IDENTIFICATIONMODULE_REV_MINOR	Section 6.2.5 on page 52
0x006	IDENTIFICATIONDATE_HI	Section 6.2.6 on page 52
0x007	IDENTIFICATIONDATE_LO	Section 6.2.7 on page 53
0x008:0x009	IDENTIFICATIONTIME	Section 6.2.8 on page 53
0x010	SYSTEMMODE_GPIO0	Section 6.2.9 on page 54
0x011	SYSTEMMODE_GPIO1	Section 6.2.10 on page 55
0x012	SYSTEMHISTORY_CTRL	Section 6.2.11 on page 56
0x014	SYSTEMINTERRUPT_CONFIG_GPIO	Section 6.2.12 on page 57
0x015	SYSTEMINTERRUPT_CLEAR	Section 6.2.13 on page 57
0x016	SYSTEMFRESH_OUT_OF_RESET	Section 6.2.14 on page 58
0x017	SYSTEMGROUPED_PARAMETER_HOLD	Section 6.2.15 on page 58
0x018	SYSRANGESTART	Section 6.2.16 on page 59
0x019	SYSRANGETHRESH_HIGH	Section 6.2.17 on page 59
0x01A	SYSRANGETHRESH_LOW	Section 6.2.18 on page 60
0x01B	SYSRANGEINTERMEASUREMENT_PERIOD	Section 6.2.19 on page 60
0x01C	SYSRANGEMAX_CONVERGENCE_TIME	Section 6.2.20 on page 60
0x01E	SYSRANGECROSSTALK_COMPENSATION_RATE	Section 6.2.21 on page 61
0x021	SYSRANGECROSSTALK_VALID_HEIGHT	Section 6.2.22 on page 61
0x022	SYSRANGEEARLY_CONVERGENCE_ESTIMATE	Section 6.2.23 on page 61
0x024	SYSRANGEPART_TO_PART_RANGE_OFFSET	Section 6.2.24 on page 62
0x025	SYSRANGERANGE_IGNORE_VALID_HEIGHT	Section 6.2.25 on page 62
0x026	SYSRANGERANGE_IGNORE_THRESHOLD	Section 6.2.26 on page 62
0x02C	SYSRANGEMAX_AMBIENT_LEVEL_MULT	Section 6.2.27 on page 63
0x02D	SYSRANGERANGE_CHECK_ENABLES	Section 6.2.27 on page 63
0x02E	SYSRANGEVHV_RECALIBRATE	Section 6.2.29 on page 64
0x031	SYSRANGEVHV_REPEAT_RATE	Section 6.2.30 on page 64
0x038	SYSALSSTART	Section 6.2.31 on page 65
0x03A	SYSALSTHRESH_HIGH	Section 6.2.32 on page 65
0x03C	SYSALSTHRESH_LOW	Section 6.2.33 on page 66



Table 28. Register summary (continued)			
Offset	Register name	Reference	
0x03E	SYSALS_INTERMEASUREMENT_PERIOD	Section 6.2.34 on page 66	
0x03F	SYSALSANALOGUE_GAIN	Section 6.2.35 on page 67	
0x040	SYSALS_INTEGRATION_PERIOD	Section 6.2.36 on page 67	
0x04D	RESULTRANGE_STATUS	Section 6.2.37 on page 68	
0x04E	RESULTALS_STATUS	Section 6.2.38 on page 69	
0x04F	RESULTINTERRUPT_STATUS_GPIO	Section 6.2.39 on page 70	
0x050	RESULTALS_VAL	Section 6.2.40 on page 70	
0x052:0x060 (0x2)	RESULTHISTORY_BUFFER_x	Section 6.2.41 on page 71	
0x062	RESULTRANGE_VAL	Section 6.2.42 on page 72	
0x064	RESULTRANGE_RAW	Section 6.2.43 on page 72	
0x066	RESULTRANGE_RETURN_RATE	Section 6.2.44 on page 72	
0x068	RESULTRANGE_REFERENCE_RATE	Section 6.2.45 on page 73	
0x06C	RESULTRANGE_RETURN_SIGNAL_COUNT	Section 6.2.46 on page 73	
0x070	RESULTRANGE_REFERENCE_SIGNAL_COUNT	Section 6.2.47 on page 74	
0x074	RESULTRANGE_RETURN_AMB_COUNT	Section 6.2.48 on page 74	
0x078	RESULTRANGE_REFERENCE_AMB_COUNT	Section 6.2.49 on page 74	
0x07C	RESULTRANGE_RETURN_CONV_TIME	Section 6.2.50 on page 75	
0x080	RESULTRANGE_REFERENCE_CONV_TIME	Section 6.2.51 on page 75	
0x10A	READOUTAVERAGING_SAMPLE_PERIOD	Section 6.2.52 on page 75	
0x119	FIRMWAREBOOTUP	Section 6.2.52 on page 75	
0x120	FIRMWARERESULT_SCALER	Section 6.2.53 on page 76	
0x212	I2C_SLAVEDEVICE_ADDRESS	Section 6.2.55 on page 76	
0x2A3	INTERLEAVED_MODEENABLE	Section 6.2.56 on page 77	

Table 28. Register summary (continued)



6.2 Register descriptions

6.2.1 IDENTIFICATION_MODEL_ID

7	6	5	4	3	2	1	0			
identificationmodel_id										
R/W										
Address:	0x000	0x000								
Туре:	R/W									
Reset:	0xB4									
Description:										
[7:0]	identificationmodel_id: Device model identification number. 0xB4 = VL6180X									

6.2.2 IDENTIFICATION__MODEL_REV_MAJOR

7	6	5	4	3	2	1	0	
		identifi	identificationmodel_rev_major					
		R		R/W				
Address:	ress: 0x001							
Туре:	R/W							
Reset:	0x1, re	egister defaul	overwritten	at boot-up by	NVM content	s.		
Description:	1							
[2:0]	identific	identificationmodel_rev_major: Revision identifier of the Device for major change.						

6.2.3 IDENTIFICATION__MODEL_REV_MINOR

7	6	5	4	3	2	1	0		
		RESERVED	identificationmodel_rev_minor						
		R		R/W					
Address:	ddress: 0x002								
Туре:	R/W	R/W							
Reset:	0x3, re	gister default	overwritten a	at boot-up by	NVM content	ts.			
Description:									
[2:0]	identific	ationmodel_	_rev_minor: Re	vision identifie	r of the Device	for minor char	nge.		
	IDENTIFICATIONMODEL_REV_MINOR = 3 for latest ROM revision								



6.2.4 IDENTIFICATION__MODULE_REV_MAJOR

7	6	5	4	3	2	1	0			
		identific	identificationmodule_rev_major							
		R				R/W				
Address:	s: 0x003									
Туре:	R/W	R/W								
Reset:	0x1, re	gister defaul	t overwritten	at boot-up by	/ NVM content	ts.				
Description:										
[2:0]		identificationmodule_rev_major: Revision identifier of the Module Package for major change Used to store NVM content version. Contact ST for current information.								

6.2.5 IDENTIFICATION__MODULE_REV_MINOR

7	6	5	4	3	2	1	0		
		RESERVED	identificationmodule_rev_minor						
		R	R/W						
Address:	ddress: 0x004								
Туре:	R/W	R/W							
Reset:	0x2, re	gister defaul	overwritten	at boot-up by	NVM content	is.			
Description:									
[2:0]		identificationmodule_rev_minor: Revision identifier of the Module Package for minor change. Used to store NVM content version. Contact ST for current information.							

6.2.6 IDENTIFICATION__DATE_HI

7	6	5	4	3	2	1	0		
	identificat	ionyear		identificationmonth					
	R	W			R	W			
Address:	0x006	0x006							
Туре:	R/W	R/W							
Reset:	0xYY,	register defa	ult overwritter	at boot-up b	y NVM conte	nts.			
Description	Part of	the register	set that can b	e used to uni	iquely identify	a module.			
[7:4]	identific	identificationyear: Last digit of manufacturing year (bits[3:0]).							
[3:0]	identific	identificationmonth: Manufacturing month (bits[3:0]).							



6.2.7 IDENTIFICATION__DATE_LO

7	6	5	4	3	2	1	0			
		identificationphase								
		R/W	R/W							
Address:	0x007	0x007								
Туре:	R/W									
Reset:	0xYY,	register defau	ılt overwritter	n at boot-up b	y NVM conte	nts.				
Description	Part of	Part of the register set that can be used to uniquely identify a module.								

[7:3]	identificationday: Manufacturing day (bits[4:0]).
[2:0]	identificationphase: Manufacturing phase identification (bits[2:0]).

6.2.8 IDENTIFICATION_TIME

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
identification_time															
R/W															
Address: 0x008:0x009															
Туре:	Type: R/W														
Reset	:		0xYYY	Y, regi	ster de	efault o	verwrit	tten at	boot-u	p by N	VM co	ntents.			
Descr	Description: Part of the register set that can be used to uniquely identify a module.														
	[15:0] identificationtime: Time since midnight (in seconds) = register_value * 2														



6.2.9 SYSTEM_MODE_GPIO0

7	6	5	4	3	2	1	0
RESERVED	systemgpio0_is_xshutdown	systemgpio0_polarity		c	systemgpiou_select		RESERVED
R	R/W	R/W		R	/W		R/W

Address:	0x010
/ (aa) 000.	0.010

Reset: 0x60

Description:

[6]	systemgpio0_is_xshutdown: Priority mode - when enabled, other bits of the register are ignored. GPIO0 is main XSHUTDOWN input. 0: Disabled 1: Enabled - GPIO0 is main XSHUTDOWN input.
[5]	systemgpio0_polarity: Signal Polarity Selection. 0: Active-low 1: Active-high
[4:1]	systemgpio0_select: Functional configuration options. 0000: OFF (Hi-Z) 1000: GPIO Interrupt output
[0]	Reserved. Write 0.



6.2.10 SYSTEM_MODE_GPI01

7	6	5	4	3	2	1	0					
systemgpio1polarity					RESERVED							
F	R R/W R/W					R/W						
Address: Type: Reset: Description:	0x011 R/W 0x20											
[5] systemgpio1_polarity: Signal Polarity Selection. 0: Active-low 1: Active-high												
[4:1]	[4:1] systemgpio1_select: Functional configuration options. 0000: OFF (Hi-Z) 1000: GPIO Interrupt output											
[0]	Reserve	ed. Write 0.				Reserved. Write 0.						



6.2.11 SYSTEM_HISTORY_CTRL

7	6	5	4	3	2	1	0
		RESERVED			systemhistory_buffer_clear	systemhistory_buffer_mode	systemhistory_buffer_enable
		R			R/W	R/W	R/W

Address: 0x012

Type: R/W

Reset: 0x0

Description:

[2]	systemhistory_buffer_clear: User-command to clear history (FW will auto-clear this bit when clear has completed). 0: Disabled 1: Clear all history buffers
[1]	systemhistory_buffer_mode: Select mode buffer results for: 0: Ranging (stores the last 8 ranging values (8-bit) 1: ALS (stores the last 8 ALS values (16-bit)
[0]	systemhistory_buffer_enable: Enable History buffering. 0: Disabled 1: Enabled



6.2.12 SYSTEM_INTERRUPT_CONFIG_GPIO

7	6	5	4	3	2	1	0
RESE	RVED	als_int_mode			range_int_mode		
R			R/W			R/W	

Address:	0x014
Туре:	R/W

Reset: 0x0

Description:

[5:3]	als_int_mode: Interrupt mode source for ALS readings: 0: Disabled 1: Level Low (value < thresh_low) 2: Level High (value > thresh_high) 3: Out Of Window (value < thresh_low OR value > thresh_high)
	4: New sample ready
[2:0]	range_int_mode: Interrupt mode source for Range readings: 0: Disabled
	1: Level Low (value < thresh_low)
	2: Level High (value > thresh_high)
	3: Out Of Window (value < thresh_low OR value > thresh_high) 4: New sample ready

6.2.13 SYSTEM_INTERRUPT_CLEAR

7	6	5	4	3	2	1	0		
		RESERVED	1		int_clear_sig				
R					R/W				
Address:	0x015								
Туре:	R/W								
Reset:	0x0								
Description:									
[2:0]	int_clea	ar_sig: Interrup	t clear bits. Wr	iting a 1 to eac	h bit will clear	the intended int	terrupt.		
		Clear Range I	nt						
		Clear ALS Int							
	Bit [2] -	Clear Error Int							



6.2.14 SYSTEM_FRESH_OUT_OF_RESET

7	6	5	4	3	2	1	0		
			RESERVED				fresh_out_of_reset		
			R				R/W		
Address:	0x016								
Туре:	R/W								
Reset:	0x1								
Description:	1								
[0]	[0] fresh_out_of_reset: Fresh out of reset bit, default of 1, user can set this to 0 after initial boot and can therefore use this to check for a reset condition								

6.2.15 SYSTEM__GROUPED_PARAMETER_HOLD

7	6	5	4	3	2	1	0		
/	0	5	4	3	2	I	-		
			RESERVED				grouped_parameter_hold		
		R							
Address:	0x017								
Туре:	R/W								
Reset:	0x0								
Description:									
[0]	0: Data 1: Data Usage: settings SYSTE SYSRA SYSAL SYSAL SYSAL	is stable - FW being updated set to 0x01 firs are used by th M_INTERRU NGETHRES	is safe to copy I - FW not safe st, write any of he firmware at PT_CONFIG_0 SH_HIGH SH_LOW FION_PERIOD JE_GAIN HIGH	to copy the registers lis the start of the GPIO	sted below, the	s being update en set to 0x00 s ment.			

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6.2.16 SYSRANGE_START

7	6	5	4	3	2	1	0
	RES RES RES RES RES RES RES RES RES RES						sysrangestartstop
	R						R/W

Ту	oe:	R/W
_		

Reset: 0x0

Description:

[1]	sysrangemode_select: Device Mode select 0: Ranging Mode Single-Shot 1: Ranging Mode Continuous
[0]	sysrangestartstop: StartStop trigger based on current mode and system configuration of device_ready. FW clears register automatically. Setting this bit to 1 in single-shot mode starts a single measurement. Setting this bit to 1 in continuous mode will either start continuous operation (if stopped) or halt continuous operation (if started). This bit is auto-cleared in both modes of operation.

6.2.17 SYSRANGE__THRESH_HIGH

7	6	5	4	3	2	1	0					
sysrangethresh_high												
R/W												
Address:	0x019											
Туре:	R/W											
Reset:	0xFF											
Description:												
[7:0]	sysrang	ethresh_hig	h: High Thresh	nold value for ra	anging compar	ison. Range 0-	255mm.					



6.2.18 SYSRANGE__THRESH_LOW

7	6	5	4	3	2	1	0						
	sysrangethresh_low												
R/W													
Address:	0x01A												
Туре:	R/W												
Reset:	0x0												
Description:													
[7:0]	sysrang	jethresh_lov	v: Low Thresho	old value for rai	nging comparis	on. Range 0-2	255mm.						

6.2.19 SYSRANGE_INTERMEASUREMENT_PERIOD

7	6	5	4	3	2	1	0						
	sysrangeintermeasurement_period												
	R/W												
Address:	ddress: 0x01B												
Туре:	R/W	R/W											
Reset:	0xFF												
Description:	Description:												
[7:0]	•												

6.2.20 SYSRANGE_MAX_CONVERGENCE_TIME

7	6	5	4	3	2	1	0				
RESE	RVED		sysrangemax_convergence_time								
	R R/W										
Address:	0x01C										
Туре:	R/W										
Reset:	0x31										
Description	:										

 sysrangemax_convergence_time: Maximum time to run measurement in Ranging modes. Range 1 - 63 ms (1 code = 1 ms); Measurement aborted when limit reached to aid power reduction. For example, 0x01 = 1ms, 0x0a = 10ms.
Note: Effective max_convergence_time depends on readout_averaging_sample_period setting.



6.2.21 SYSRANGE_CROSSTALK_COMPENSATION_RATE

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
sysrangecrosstalk_compensation_rate															
R/W															
Addre	ess:		0x01E												
Туре:			R/W												
Reset	:		0x0												
Descr	iption														
	[15:0]		sysrang format).		sstalk_	comper	nsation_	_rate: U	ser-con	trolled	crossta	lk comp	ensatio	n in Mc	ps (9.7

6.2.22 SYSRANGE_CROSSTALK_VALID_HEIGHT

7	6	5	4	3	2	1	0							
	sysrangecrosstalk_valid_height													
	R/W													
Address:	0x021													
Туре:	R/W	R/W												
Reset:	0x14													
Description:	- -													
[7:0]	sysrang comper		valid_height: N	1inimum range	value in mm to	o qualify for cro	oss-talk							

6.2.23 SYSRANGE_EARLY_CONVERGENCE_ESTIMATE

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	sysrangeearly_convergence_estimate														
	R/W														
Addre	SS:		0x022												
Туре:			R/W												
Reset	:		0x0												
Descr	iption:														
	[15:0]		FW carr converg Note: T SYSRA	jence ra his regi	ate is bo ster mu	elow us ist be c	er input onfigure	t value, ed othe	the op wise E	eration	aborts t	o save	power.	asureme	ent. If



6.2.24 SYSRANGE_PART_TO_PART_RANGE_OFFSET

7	6	5	4	3	2	1	0						
	sysrangepart_to_part_range_offset												
R/W													
Address:	0x024	0x024											
Туре:	R/W												
Reset:	0xYY,	register defa	ult overwritter	at boot-up b	y NVM conte	nts.							
Description:	Description:												
[7:0]	sysrang	gepart_to_pa	art_range_offse	et: 2s complem	ent format.								

6.2.25 SYSRANGE_RANGE_IGNORE_VALID_HEIGHT

7	6	6 5 4 3 2 1 0												
	sysrange_range_ignore_valid_height													
	R/W													
Address:	ddress: 0x025													
Туре:	R/W													
Reset:	0x0, re	gister defau	It overwritten a	at boot-up by	NVM content	s.								
Description:														
[7:0]	[7:0] sysrangerange_ignore_valid_height: Range below which ignore threshold is applied. Aim is to ignore the cover glass i.e. low signal rate at near distance. Should not be applied to low reflectance target at far distance. Range in mm. Note: It is recommended to set this register to 255 if the range ignore feature is used.													

6.2.26 SYSRANGE_RANGE_IGNORE_THRESHOLD

										-					
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
						sysrang	erange	_ignore_t	hreshold						
	R/W														
Addre	ess:		0x026												
Type: R/W															
Reset	:		0x00												
Descr	iption	:													
	[15:0]		, ,	out ran	ging du	e to cov	/er glas	s when	there is	s no tar	n thresh get abo	0			



6.2.27 SYSRANGE_MAX_AMBIENT_LEVEL_MULT

7	6	5	4	3	2	1	0				
· · ·	•	Ũ		ambient_level_mult	-		Ĵ				
R/W											
Address:	0x02C										
Туре:	R/W										
Reset:	0xA0,	register defa	ult overwritter	n at boot-up b	y NVM conten	nts.					
Description:											

[7:0]	sysrangemax_ambient_level_mult: User input value to multiply return_signal_count for
	AMB:signal ratio check. If (amb counts * 6) > return_signal_count * mult then abandon
	measurement due to high ambient (4.4 format).

6.2.28 SYSRANGE_RANGE_CHECK_ENABLES

7	6	5	4	3	2	1	0
	RESERVED		sysrangesignal_to_noise_enable	0	0	sysrangerange_ignore_enable	sysrangeearly_convergence_enable
	R		R/W	R/W	R	R/W	R/W

Address: 0x02D

Type: R/W

Reset: 0x11, register default overwritten at boot-up by NVM contents.

Description:

[4]	sysrangesignal_to_noise_enable: Measurement enable/disable
[1]	sysrange_range_ignore_enable: Measurement enable/disable
[0]	sysrangeearly_convergence_enable: Measurement enable/disable



6.2.29 SYSRANGE__VHV_RECALIBRATE

7	6	5	4	3	2	1	0
			L >			sysrangevhv_status	sysrangevhv_recalibrate
	R/W	R/W					

Address:	0x02E
Auu 633.	

Туре:	R/W

0x0

Reset:

Description:

Becchption	
[1]	sysrangevhv_status: FW controlled status bit showing when FW has completed auto-vhv process. 0: FW has finished autoVHV operation 1: During autoVHV operation
[0]	sysrangevhv_recalibrate: User-Controlled enable bit to force FW to carry out recalibration of the VHV setting for sensor array. FW clears bit after operation carried out. 0: Disabled 1: Manual trigger for VHV recalibration. Can only be called when ALS and ranging are in STOP mode

6.2.30 SYSRANGE_VHV_REPEAT_RATE

7	6	5	4	3	2	1	0						
	sysrangevhv_repeate_rate												
	R/W												
Address:	0x031												
Туре:	Type: R/W												
Reset:	0x0												
Description:													
[7:0]	[7:0] sysrangevhv_repeat_rate: User entered repeat rate of auto VHV task (0 = off, 255 = after every 255 measurements)												



6.2.31 SYSALS_START

_	-	-		-	-							
7	6	5	4	3	2	1	0					
		sysalsmode_select	sysalsstartstop									
	R R/W R/V											
Address:	0x038											
Туре:	R/W											
Reset:	0x0											
Description:												
[1]	0: ALS I	_mode_select: Mode Single-S Mode Continue		select								
[0]	 [0] sysalsstartstop: Start/Stop trigger based on current mode and system configuration of device_ready. FW clears register automatically. Setting this bit to 1 in single-shot mode starts a single measurement. Setting this bit to 1 in continuous mode will either start continuous operation (if stopped) or half continuous operation (if started). This bit is auto-cleared in both modes of operation. See 6.2.56: INTERLEAVED_MODEENABLE for combined ALS and Range operation. 											

6.2.32 SYSALS_THRESH_HIGH

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	sysalsthresh_high														
	R/W														
Addre	Address: 0x03A														
Туре:			R/W												
Reset:	:		0xFFF	F											
Descri	Description:														
	[15:0] sysalsthresh_high: High Threshold value for ALS comparison. Range 0-65535 codes.														



6.2.33 SYSALS_THRESH_LOW

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	sysalsthresh_low														
							R/	W							
Addre	SS:		0x03C												
Туре:			R/W												
Reset			0x0												
Descr	iption:														
	[15:0]		sysals_	_thresh	_low: L	ow Thr	eshold	value fo	or ALS (compar	ison. Ra	ange 0-	65535 (codes.	

6.2.34 SYSALS_INTERMEASUREMENT_PERIOD

7	6	5	4	3	2	1	0	
	sysalsintermeasurement_period							
R/W								
Address:	0x03E							
Туре:	R/W	R/W						
Reset:	Reset: 0xFF							
Description:	Description:							
[7:0]	[7:0] sysalsintermeasurement_period: Time delay between measurements in ALS continuous mode. Range 0-254 (0 = 10ms). Step size = 10ms.							



6.2.35 SYSALS_ANALOGUE_GAIN

7	6	5	4	3	2	1	0		
		RESERVED	•		sysa	lsanalogue_gain	_light		
		R				R/W			
Address:	0x03F								
Туре:	: R/W								
Reset:	Reset: 0x06								
Description:	Description:								
[2:0] sysalsanalogue_gain_light: ALS analogue gain (light channel) 0: ALS Gain = 20 1: ALS Gain = 10 2: ALS Gain = 5.0 3: ALS Gain = 2.5 4: ALS Gain = 1.67 5: ALS Gain = 1.25 6: ALS Gain = 1.0 7: ALS Gain = 40 Controls the "light" channel gain. Note: Upper nibble should be set to 0x4 i.e. For ALS gain of 1.0 write 0x46.									

6.2.36 SYSALS_INTEGRATION_PERIOD

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	RESERVED							sysalsintegration_period							
R						R/W									
Address: 0x040															
Type: R/W															
Reset	:		0x0												
Descr	Description:														
[8:0] sysalsintegration_period: Integration period for ALS mode. 1 code = 1 ms (0 = 1 ms). Recommended setting is 100 ms (0x63).															



6.2.37 RESULT_RANGE_STATUS

7	6	5	4	3	2	1	0
				result_range_min_threshold_hit	resultrange_max_threshold_hit	resultrange_measurement_ready	resultrange_device_ready
	R			R	R	R	R

Туре:	R

Reset: 0x1

Description:

[7:4]	resultrange_error_code: Specific error codes 0000: No error 0001: VCSEL Continuity Test 0010: VCSEL Watchdog Test 0011: VCSEL Watchdog 0100: PLL1 Lock 0101: PLL2 Lock
	0110: Early Convergence Estimate 0111: Max Convergence 1000: No Target Ignore 1001: Not used 1010: Not used 1011: Max Signal To Noise Ratio 1100: Raw Ranging Algo Underflow 1100: Raw Ranging Algo Overflow 1101: Raw Ranging Algo Overflow 1110: Ranging Algo Underflow 1111: Ranging Algo Overflow
[3]	resultrange_min_threshold_hit: Legacy register - DO NOT USE Use instead 6.2.39: RESULTINTERRUPT_STATUS_GPIO
[2]	resultrange_max_threshold_hit: Legacy register - DO NOT USE Use instead 6.2.39: RESULTINTERRUPT_STATUS_GPIO
[1]	resultrange_measurement_ready: Legacy register - DO NOT USE Use instead 6.2.39: RESULTINTERRUPT_STATUS_GPIO
[0]	resultrange_device_ready: Device Ready. When set to 1, indicates the device mode and configuration can be changed and a new start command will be accepted. When 0, indicates the device is busy.



6.2.38 RESULT_ALS_STATUS

7	6	5	4	3	2	1	0
	result als error code			result_als_min_threshold_hit	resultals_max_threshold_hit	result_als_measurement_ready	resultals_device_ready
	R			R	R	R	R
Address:	0x04E						
Type: R							
Reset:	Reset: 0x1						
Description:							
[7:4]	0000: N 0001: O		e: Specific erro	or and debug co	odes		
[3]			hold_hit: Lega ESULTINTE				
[2]	[2] result_als_max_threshold_hit: Legacy register - DO NOT USE Use instead 6.2.39: RESULT_INTERRUPT_STATUS_GPIO						
[1]	[1] resultals_measurement_ready: Legacy register - DO NOT USE Use instead 6.2.39: RESULTINTERRUPT_STATUS_GPIO						
[0] result_als_device_ready: Device Ready. When set to 1, indicates the device mode and configuration can be changed and a new start command will be accepted. When 0, indicate the device is busy.							



6.2.39 RESULT_INTERRUPT_STATUS_GPIO

7	6	5	4	3	2	1	0	
result_int_error_gpio			result_int_als_gpio		result_int_range_gpio			
R			R			R		

Address:	0x04F
----------	-------

R

Reset: 0x0

Description:

Туре:

[7:6]	result_int_error_gpio: Interrupt bits for Error: 0: No error reported 1: Laser Safety Error 2: PLL error (either PLL1 or PLL2)
[5:3]	result_int_als_gpio: Interrupt bits for ALS: 0: No threshold events reported 1: Level Low threshold event 2: Level High threshold event 3: Out Of Window threshold event 4: New Sample Ready threshold event
[2:0]	result_int_range_gpio: Interrupt bits for Range: 0: No threshold events reported 1: Level Low threshold event 2: Level High threshold event 3: Out Of Window threshold event 4: New Sample Ready threshold event

6.2.40 RESULT_ALS_VAL

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	resultals_ambient_light														
	R														
Address: 0x050															
Туре:	Type: R														
Reset	:		0x0												
Descr	iption:	1													
	[15:0] result_als_ambient_light: 16 Bit ALS count output value. Lux value depends on Gain and integration settings and calibrated lux/count setting.												nd		



6.2.41 RESULT__HISTORY_BUFFER_x

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RESULTHISTOR Y_BUFFER_0		resulthistory_buffer_0												L		
RESULTHISTOR Y_BUFFER_1		resulthistory_buffer_1														
RESULTHISTOR Y_BUFFER_2		result_history_buffer_2														
RESULTHISTOR Y_BUFFER_3		resulthistory_buffer_3														
RESULTHISTOR Y_BUFFER_4							resu	ulthist	ory_buff	er_4						
RESULTHISTOR Y_BUFFER_5	resulthistory_buffer_5															
RESULTHISTOR Y_BUFFER_6		resulthistory_buffer_6														
RESULTHISTOR Y_BUFFER_7							resu	ulthist	ory_buff	er_7						
									٦							

Туре:	R
Reset:	0x0

Description:	See also 6.2.11: SYSTEM_	_HISTORY_CTRL
--------------	--------------------------	---------------

RESULTHISTOR	resulthistory_buffer_0: Range/ALS result value.
Y_BUFFER_0:	Range mode; Bits[15:8] range_val_latest; Bits[7:0] range_val_d1;
[15:0]	ALS mode; Bits[15:0] als_val_latest
RESULTHISTOR	resulthistory_buffer_1: Range/ALS result value.
Y_BUFFER_1:	Range mode; Bits[15:8] range_val_d2; Bits[7:0] range_val_d3;
[15:0]	ALS mode; Bits[15:0] als_val_d1
RESULTHISTOR	resulthistory_buffer_2: Range/ALS result value.
Y_BUFFER_2:	Range mode; Bits[15:8] range_val_d4; Bits[7:0] range_val_d5;
[15:0]	ALS mode; Bits[15:0] als_val_d2
RESULTHISTOR	resulthistory_buffer_3: Range/ALS result value.
Y_BUFFER_3:	Range mode; Bits[15:8] range_val_d6; Bits[7:0] range_val_d7;
[15:0]	ALS mode; Bits[15:0] als_val_d3
RESULTHISTOR	resulthistory_buffer_4: Range/ALS result value.
Y_BUFFER_4:	Range mode; Bits[15:8] range_val_d8; Bits[7:0] range_val_d9;
[15:0]	ALS mode; Bits[15:0] als_val_d4
RESULTHISTOR	resulthistory_buffer_5: Range/ALS result value.
Y_BUFFER_5:	Range mode; Bits[15:8] range_val_d10; Bits[7:0] range_val_d11;
[15:0]	ALS mode; Bits[15:0] als_val_d5
RESULTHISTOR	resulthistory_buffer_6: Range/ALS result value.
Y_BUFFER_6:	Range mode; Bits[15:8] range_val_d12; Bits[7:0] range_val_d13;
[15:0]	ALS mode; Bits[15:0] als_val_d6
RESULTHISTOR	resulthistory_buffer_7: Range/ALS result value.
Y_BUFFER_7:	Range mode; Bits[15:8] range_val_d14; Bits[7:0] range_val_d15;
[15:0]	ALS mode; Bits[15:0] als_val_d7



6.2.42 RESULT_RANGE_VAL

7	6	5	4	3	2	1	0							
	result_range_val													
R														
Address: 0x062														
Туре:	R													
Reset:	0x0													
Description:														
[7:0]	· · ·													

6.2.43 RESULT_RANGE_RAW

7	6	5	4	3	2	1	0							
	resultrange_raw													
	R													
Address:	0x064													
Туре:	R													
Reset:	0x0													
Description:														
[7:0]	·													

6.2.44 RESULT_RANGE_RETURN_RATE

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	resultrange_return_rate														
	R														
Address: 0x066															
Type:			R												
Reset	:		0x0												
Descr	Description:														
	[15:0] resultrange_return_rate: sensor count rate of signal returns correlated to IR emitter. Computed from RETURN_SIGNAL_COUNT / RETURN_CONV_TIME. Mcps 9.7 format												t		


6.2.45 **RESULT_RANGE_REFERENCE_RATE**

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
						result	trange_	reference	e_rate						
							F	२							
Addre	SS:		0x068												
Туре:			R												
Reset	:		0x0												
Descr	iption:	:													
	[15:0]		REFER	ENCE_ oth arra	SIGNA	L_COL	e: senso JNT / R t the sa	ETURN	LCON	/_TIME	E. Mcps	9.7 for	mat	•	

6.2.46 RESULT_RANGE_RETURN_SIGNAL_COUNT

	30 29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
											res	ult	rang	e_re	turn_	_sign	al_co	ount												
														ł	R															
Add	lress:	:		(0x0	6C																								
Туре	e:			I	R																									
Res	et:			(0x0																									
Des	cripti	ion:	1																											
	[31:	:0]					_ran er c	•			•			nt: :	sen	sor	coui	nt o	utpu	ut va	lue	attı	ibut	ted t	to si	igna	al co	orrel	atec	d to



6.2.47 RESULT_RANGE_REFERENCE_SIGNAL_COUNT

31 30 29 28 27	26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0
	resultrange_reference_signal_count
	R
Address:	0x070
Туре:	R
Reset:	0x0
Description:	
[31:0]	resultrange_reference_signal_count: sensor count output value attributed to signal correlated to IR emitter on the Reference array.

6.2.48 RESULT_RANGE_RETURN_AMB_COUNT

31	3	0 29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
												res	sult_	_ranç	ge_re	eturn_	_amt	o_coi	unt												
															F	२															
Ad	dı	ress	:			0x0	74																								
Тур	pe	:				R																									
Re	se	et:				0x0																									
De	sc	cript	ion																												
		[31	:0]				al o	n th					b_c /. M																		

6.2.49 RESULT_RANGE_REFERENCE_AMB_COUNT

31	30	0 29	28	27	26	25	24	23	22	21	20	19	18	17	16	6 15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
												resu	ltr	ange	_re	eferenc	e_ar	nb_c	ount	t											
																R															
Ad	dr	ess:				0x0	78																								
Тур	pe	:				R																									
Re	se	et:				0x0)																								
De	sc	ripti	on:	1																											
		[31:	0]					- '	-	-		_	-	_		nt: se ray.	ensc	or co	bun	t ou	tput	val	ue a	attril	oute	ed to	o un	corr	elat	ed	



6.2.50 RESULT_RANGE_RETURN_CONV_TIME

31 30 29 28 27	26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0
	resultrange_return_conv_time
	R
Address:	0x07C
Туре:	R
Reset:	0x0
Description:	
[31:0]	resultrange_return_conv_time: sensor count output value attributed to signal on the Return array.

6.2.51 RESULT_RANGE_REFERENCE_CONV_TIME

31	30) 29	28	27	26	25	24	23	22	21	20	19	9 18	17	16	6 15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
												res	sultr	ange	e_re	eferen	ce_c	onv_	time	•											
																R															
Ad	dr	ess:				0x0	080																								
Тур	e:	:				R																									
Re	se	t:				0x0)																								
De	sc	ripti	on:																												
		[31:	0]				ult erer		•		eren	ce	_con	v_ti	ime	e: sei	ารอเ	r co	unt	out	out	valu	ie a	ttrib	uteo	d to	sigr	nal o	on tl	ne	

6.2.52 READOUT__AVERAGING_SAMPLE_PERIOD

7	6	5	4	3	2	1	0
			readout_averagi	ng_sample_period			•
			R	/W			
Address:	0x10A						
Туре:	R/W						
Reset:	0x30						
Description:							
[7:0]	adjuste effective Effective Section	d from 0 to 255 e max converg e max converg 2.7.1: Range	5. Increasing th ence time and jence time = m <i>timing</i>). Each u	e sampling pe increases pow ax convergenc unit sample per	eadout averagi riod decreases er consumption e time - readou iod correspond ng is 48 which	noise but also n: ut averaging p ls to around 64	o reduces the eriod (see 4.5 μs



6.2.53 FIRMWARE_BOOTUP

7	6	5	4	3	2	1	0
			RESERVED				firmwarebootup
			R				R/W
Address:	0x119						
Туре:	R/W						
Reset:	0x1						
Description:							
[0]	firmwar	ebootup: FV	/ must set bit c	once initial boo	t has been com	npleted.	

6.2.54 FIRMWARE__RESULT_SCALER

7	6	5	4	3	2	1	0
	RESE	RVED	•		firmwareals	_result_scaler	
	F	२			R/	W	
Address:	0x120						
Туре:	R/W						
Reset:	0x1						
Description:							
[3:0]	firmwar	eals_result_	scaler: Bits [3:	0] analogue ga	iin 1 to 16x		

6.2.55 I2C_SLAVE_DEVICE_ADDRESS

7	6	5	4	3	2	1	0
RESERVED			super_i	2c_slavedevice_	address		
R				R/W			
Address:	0x212						
Туре:	R/W						
Reset:	0x29						
Description:							
[6:0]			vice_address: l after power-up		able I ² C addre	ess (7-bit). Dev	vice address



6.2.56 INTERLEAVED_MODE_ENABLE

7	6	5	4	3	2	1	0
		•	interleaved_r	modeenable			•
			R	2/W			
Address:	0x2A3						
Туре:	R/W						
Reset:	0x0						
Description:							
[7:0]	Use SY	SALS_STAR	T and SYSALS	to this register SINTERMEA illy performed ii	SUREMENT_F	PERIOD to con	trol this mode



7 Outline drawing









8 Laser safety considerations

The VL6180X contains a laser emitter and corresponding drive circuitry. The laser output is designed to remain within Class 1 laser safety limits under all reasonably foreseeable conditions including single faults in compliance with IEC 60825-1:2007. The laser output will remain within Class 1 limits as long as the STMicroelectronics recommended device settings are used and the operating conditions specified in this datasheet are respected. The laser output power must not be increased by any means and no optics should be used with the intention of focusing the laser beam.

Figure 39. Class 1 laser product labe	Figure	39.	Class	1	laser	product	labe
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8.1 Compliance

Complies with 21 CFR 1040.10 and 1040.11 except for deviations pursuant to Laser Notice No.50, dated June 24, 2007.





9 Ordering information

VL6180X is currently available in the following format. More detailed information is available on request.

Table 29. Delivery format		
Order code	Description	
VL6180XV0NR/1	Tape and reel (5000 units in a reel)	

9.1 Traceability and identification

Latest ROM revision can be identified as follows: 0x002 IDENTIFICATION__MODEL_REV_MINOR = 3

The minimum information required for traceability is the content of the following registers:

0x006 - IDENTIFICATION__DATE_HI

0x007 - IDENTIFICATION__DATE_LO

0x008 - IDENTIFICATION___TIME (16-bit)

0x00A - IDENTIFICATION__CODE

With this information, the module can be uniquely identified.

Preferably, all the IDENTIFICATION register contents should be provided for traceability.

9.2 Part marking

Devices are marked on the underside as shown below. 1st line is the product ID. 2nd line is the manufacturing info. (circled in green), where the 1st four letters are the lot ID and the last 3 digits are the year + week number. Here: 338 is 2013 wk38. The final letter, circled in red, is the ROM revision ('E').



Figure 40. Part marking



9.3 Packaging

The Root part number 1 is available in tape and reel packaging as shown in *Figure 41*.





9.3.1 Package labeling

The labeling on the packing carton is shown in *Figure 42.* The latest ROM revision is indicated alongside the order code (shaded green) and also after the product marking (shaded pink).







9.4 Storage

The Root part number 1 is a MSL 3 package.

Level	Floor Life (out of bag) at Factory Ambient <30 ^o C/60% RH
3	1 Week

Table 30. Storage conditions

After this limit, dry bake to be done; 3 hours at 125°C.

9.5 ROHS compliance

The Root part number 1 is Ecopack2 compliant as per ST definition.

Devices which are ROHS compliant even with use of ROHS exemption(s) and free of Halogenated flame retardant are named ECOPACK2 devices with the following definition:

- ROHS compliant even with use of ROHS exemption(s)
- 500 ppm maximum of Antimony as oxide or organic compound in each organic assembly material (glue, substrate, mod compounds, housing...). Antimony in ceramic parts, in glass and in solder alloy is not restricted.
- 900 ppm maximum Bromine + Chlorine in each organic assembly materials (glue, substrate, mold compounds, housing...)

These values are referring to maximum total content not to extractable ions content. Purchasing specification of assembly materials can impose lower values for technical reasons.

ECOPACK2 devices are of course fully compliant to ST banned and declarable substances specification and for example cannot contain red Phosphorus flame retardant.



10 ECOPACK[®]

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



11 Revision history

Date	Revision	Changes
23-Sep-2013	1	Initial release.
30-Jan-2014	1.1	General update for latest ROM revision: Section 1.1: Technical specification updated Section 1.4: Typical application schematic updated Section 1.5: Recommended solder pad dimensions updated Notes added to Figure 5.: Recommended reflow profile Section 2.10: Ambient light sensor (ALS) updated. Section 5.1: Absolute maximum ratings added Section 5.2: Normal operating conditions extended Section 4: I2C control interface added Revised outline drawing added to Section 7: Outline drawing Class 1 laser product label added to Section 7: Outline drawing Section 9: Ordering information added information relating to device marking and package labeling
02-Apr-2014	1.2	Updates to the following sections: Section 1.5: Recommended solder pad dimensions Section 5.2: Normal operating conditions Section 5.3: Electrical characteristics Section 3.1: Proximity ranging (0 to 100mm) Added Section 3.2: ALS performance Corrected error codes in. Section 6.2.38: RESULT_ALS_STATUS Updated Section 6.2.20: SYSRANGE_MAX_CONVERGENCE_TIME Product code changed to VL6180X
09-Apr-14	2	Add documentation reference number (026171) Update Disclaimer
15-May-14	3	ALS linearity spec updated in Section 3.2: ALS performance Updated some detail in Table 1.: Technical specification Added comment to Section 1.3: Device pinout stating that pins labeled 'no connect' can optionally be connected to ground Added test condition to Section 5.3: Electrical characteristics Errata corrections in 6.2.8, 6.2.35 and 6.2.54 Section 7: Outline drawing updated (no dimensional changes) Dry bake conditions updated in Section 9.4: Storage
28-May-14	4	Added Section 8.1: Compliance
16-Jun-14	5	Re-write of Section 2: Functional description. Section 6: Device registers: Added introduction and minor corrections Section 7: Outline drawing updated to Rev B1. Supplier dependent gate mark added.

Table 31	. Document	revision	history
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Date	Revision	Changes	
20-Aug-2014	6	Updates: Section : Signal-to-noise ratio (SNR): Clarified SNR calculation. Section 6: Device registers: Corrected a clarified some register descriptions. Typical ranging performance graph updated. Delivery & manufacturing info updated.	
16-Mar-2016	7	Updates: - API integrated into datasheet Add: Section 2.7.5: Wrap Around Filter Section 2.7.6: Maximum ranging distance (DMAX) Section 4.1: I2C interface - timing characteristics	

Table 31. Document revision history (continued)



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